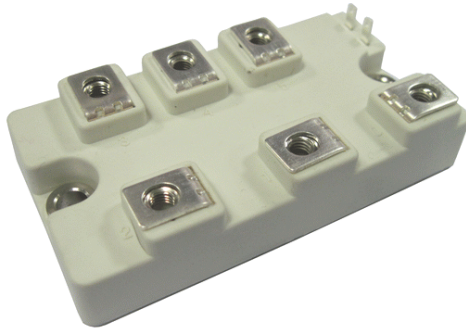




Three Phase Bridge + Thyristor

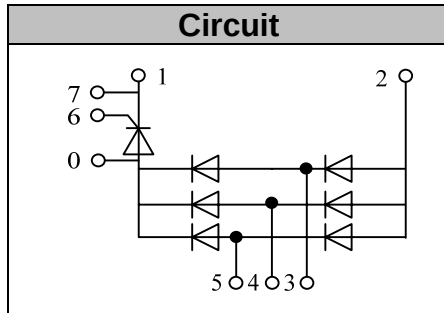
V_{RRM} / V_{DRM} 800 to 1600V
 I_{FAV} / I_{TAV} 100Amp

Features

- Blocking voltage: 800 to 1600V
- Three Phase Bridge and a Thyristor
- Isolated Module package

Applications

- Inverter for AC or DC motor control
- Current stabilized power supply
- Switching power supply
- UL E243882 approved



Module Type

TYPE	V_{RRM} / V_{DRM}	V_{RSM}
MSDT100-08	800V	900V
MSDT100-12	1200V	1300V
MSDT100-16	1600V	1700V

◆ Diode

Maximum Ratings

Symbol	Item	Conditions	Values	Units
I_D	Output Current(D.C.)	$T_c=100^{\circ}\text{C}$ Three phase full wave	100	A
I_{FSM}	Surge forward current	$t=10\text{mS}$ $T_{vj}=45^{\circ}\text{C}$	1200	A
i^2t	Circuit Fusing Consideration		7200	A^2s
V_{isol}	Isolation Breakdown Voltage(R.M.S)	a.c.50HZ;r.m.s.;1min	3000	V
T_{vj}	Operating Junction Temperature		-40 to +150	$^{\circ}\text{C}$
T_{stg}	Storage Temperature		-40 to +125	$^{\circ}\text{C}$
M_t	Mounting Torque	To terminals(M5)	$3\pm 15\%$	Nm
M_s		To heatsink(M5)	$3\pm 15\%$	Nm
Weight		Module (Approximately)	210	g

Thermal Characteristics

Symbol	Item	Conditions	Values	Units
$R_{th(j-c)}$	Thermal Impedance, max.	Junction to Case(TOTAL)	0.18	$^{\circ}\text{C}/\text{W}$
$R_{th(c-s)}$	Thermal Impedance, max.	Case to Heatsink	0.10	$^{\circ}\text{C}/\text{W}$

Electrical Characteristics

Symbol	Item	Conditions	Values	Units
V_{FM}	Forward Voltage Drop, max.	$T=25^{\circ}\text{C}$ $I_F=100\text{A}$	1.35	V
I_{RRM}	Repetitive Peak Reverse Current, max.	$T_{vj}=25^{\circ}\text{C}$ $V_{RD}=V_{RRM}$ $T_{vj}=150^{\circ}\text{C}$ $V_{RD}=V_{RRM}$	≤ 0.5 ≤ 6	mA mA

◆Thyristor

Maximum Ratings

Symbol	Item	Conditions	Values	Units
I_{TAV}	Average On-State Current	$T_c=92^{\circ}\text{C}$, Single Phase half wave 180° conduction	100	A
I_{TSM}	Surge On-State Current	$T_{VJ}=45^{\circ}\text{C}$ $t=10\text{ms}$ (50Hz), sine $V_R=0$	1200	A
i^2t	Circuit Fusing Consideration		7200	A^2s
Visol	Isolation Breakdown Voltage(R.M.S)	a.c.50HZ;r.m.s.;1 min	3000	V
T_{vj}	Operating Junction Temperature		-40 to +125	$^{\circ}\text{C}$
T_{stg}	Storage Temperature		-40 to +125	$^{\circ}\text{C}$
M_t	Mounting Torque	To terminals(M5)	3±15%	Nm
M_s		To heatsink(M5)	3±15%	Nm
di/dt	Critical Rate of Rise of On-State Current	$T_{VJ}=T_{VJM}$, $V_D=1/2V_{DRM}$, $I_G=100\text{mA}$ $d_i/d_t=0.1\text{A}/\mu\text{s}$	150	$\text{A}/\mu\text{s}$
dv/dt	Critical Rate of Rise of Off-State Voltage, min.	$T_J=T_{VJM}$, $V_D=2/3V_{DRM}$, linear voltage rise	500	$\text{V}/\mu\text{s}$

Electrical and Thermal Characteristics

Symbol	Item	Conditions	Values			Units
			Min.	Typ.	Max.	
V_{TM}	Peak On-State Voltage, max.	$T=25^{\circ}\text{C}$ $I_T=300\text{A}$			1.70	V
I_{RRM}/I_{DRM}	Repetitive Peak Reverse Current, max. / Repetitive Peak Off-State Current, max.	$T_{VJ}=T_{VJM}$, $V_R=V_{RRM}$, $V_D=V_{DRM}$			20	mA
V_{TO}	Threshold voltage	$T_{VJ} = T_{VJM}$			0.9	V
r_T	Slope resistance				2	$\text{m}\Omega$
V_{GT}	Gate Trigger Voltage, max.	$T_{VJ}=25^{\circ}\text{C}$, $V_D=6\text{V}$			3	V
I_{GT}	Gate Trigger Current, max.	$T_{VJ}=25^{\circ}\text{C}$, $V_D=6\text{V}$			150	mA
V_{GD}	Max. required DC gate voltage	$T_{VJ}=125^{\circ}\text{C}$, $V_D=2/3V_{DRM}$			0.25	V
I_{GD}	Max. required DC gate current	$T_{VJ}=125^{\circ}\text{C}$, $V_D=2/3V_{DRM}$			6	mA
I_L	Maximum latching current	$T_{VJ}=25^{\circ}\text{C}$, $R_G=33\Omega$		300	600	mA
I_H	Maximum holding current	$T_{VJ}=25^{\circ}\text{C}$, $V_D=6\text{V}$		150	250	mA
t_{gd}	Gate controlled delay time	$T_{VJ}=25^{\circ}\text{C}$, $I_G=1\text{A}$, $d_i/d_t=1\text{A}/\mu\text{s}$		1		μs
t_q	Circuit commutated turn-off time	$T_{VJ} = T_{VJM}$		100		μs
$R_{th(j-c)}$	Thermal Impedance, max.	Junction to Case			0.26	$^{\circ}\text{C}/\text{W}$
$R_{th(c-s)}$	Thermal Impedance, max.	Case to Heatsink			0.10	$^{\circ}\text{C}/\text{W}$

Performance Curves

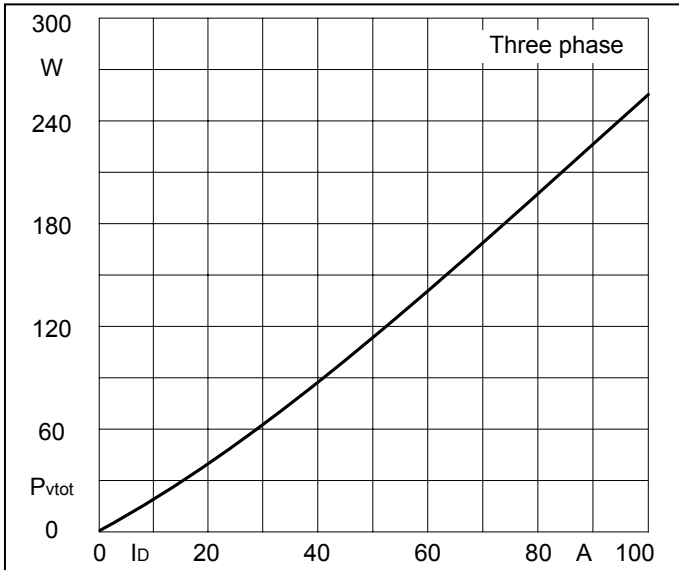


Fig1. Power dissipation

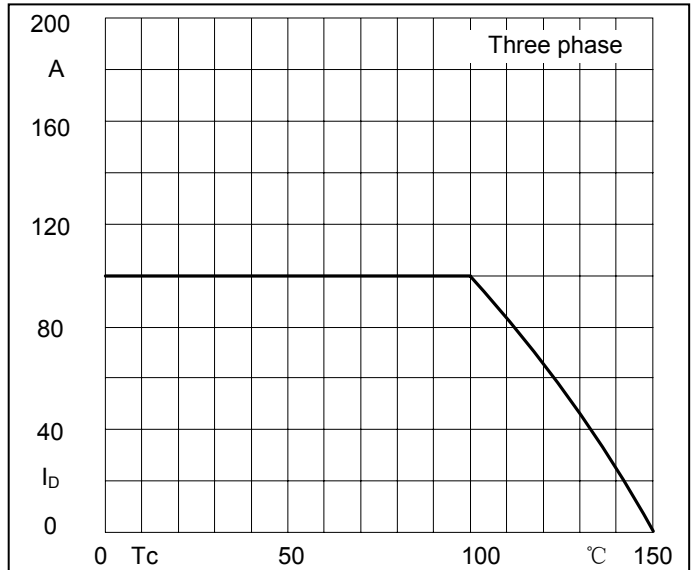


Fig2. Forward Current Derating Curve

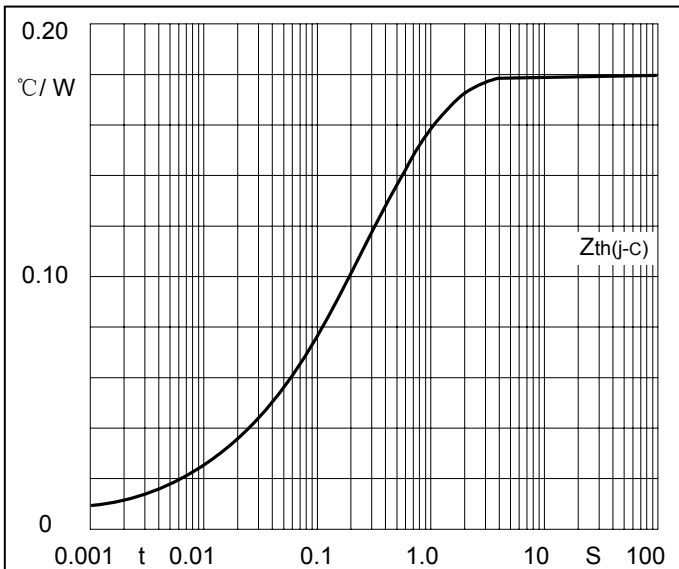


Fig3. Transient thermal impedance

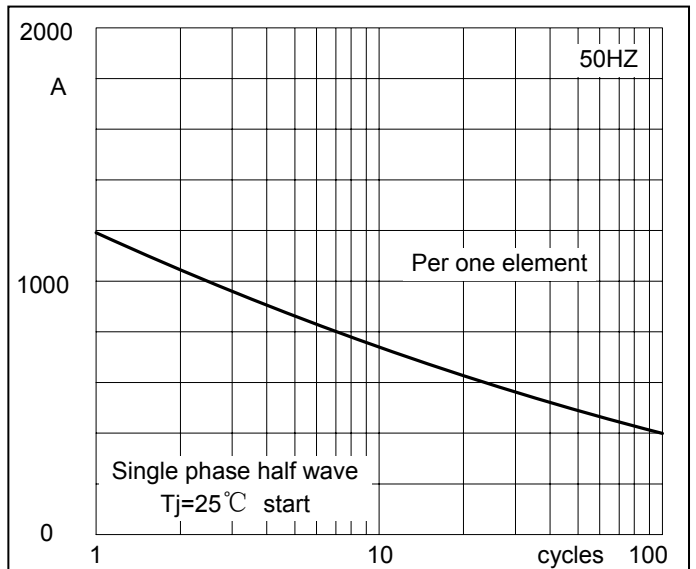


Fig4. Max Non-Repetitive Forward Surge Current

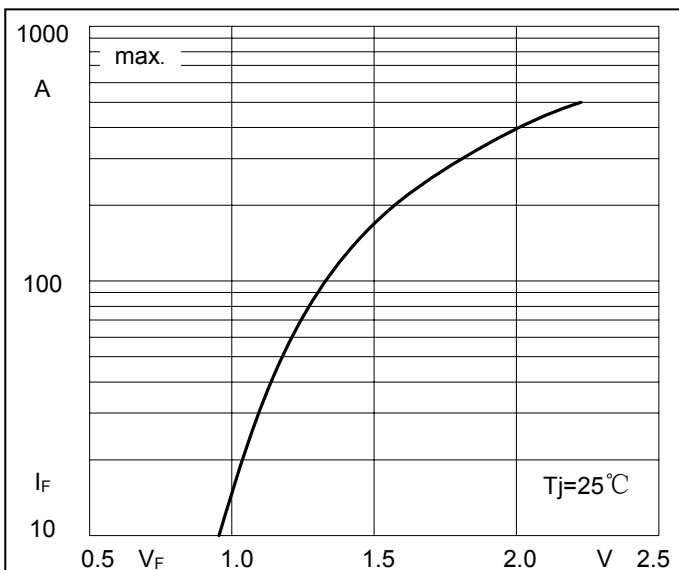


Fig5. Forward Characteristics

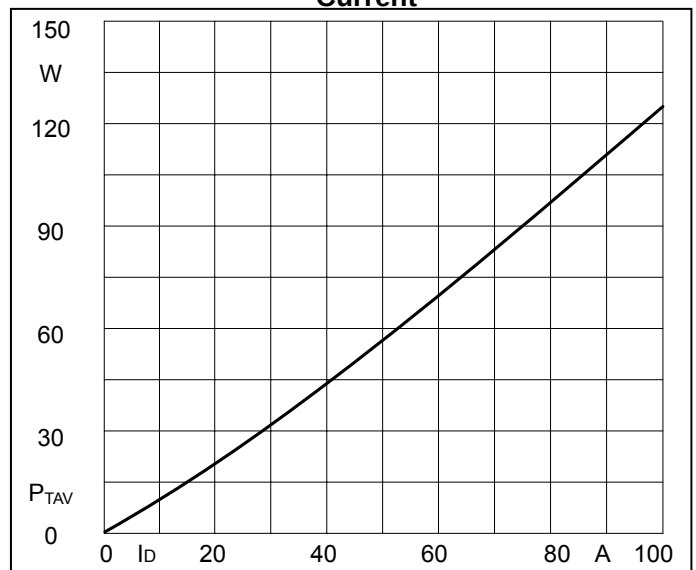


Fig6. SCR Power dissipation

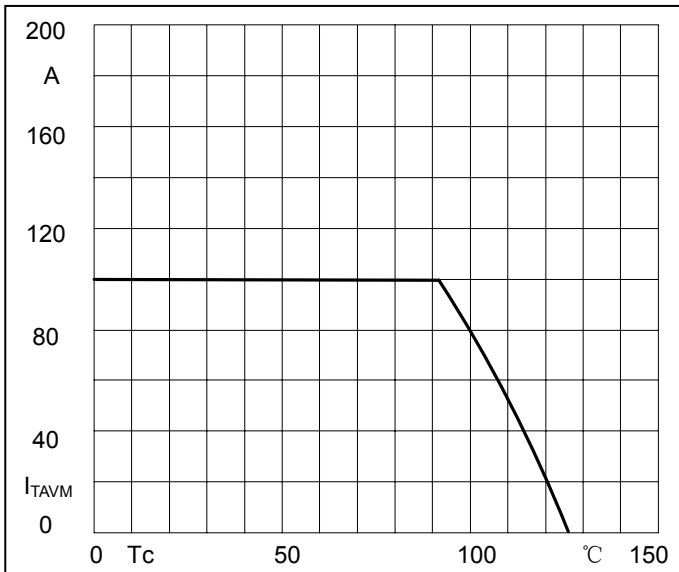


Fig7. SCR Forward Current Derating Curve

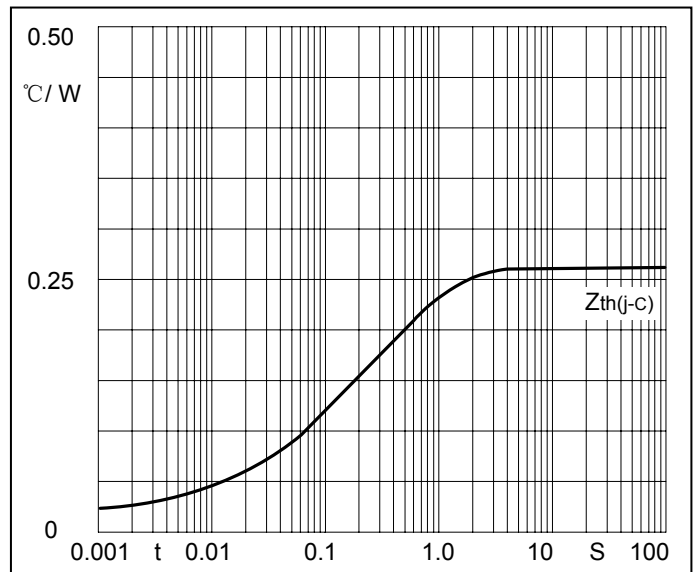


Fig8. SCR Transient thermal impedance

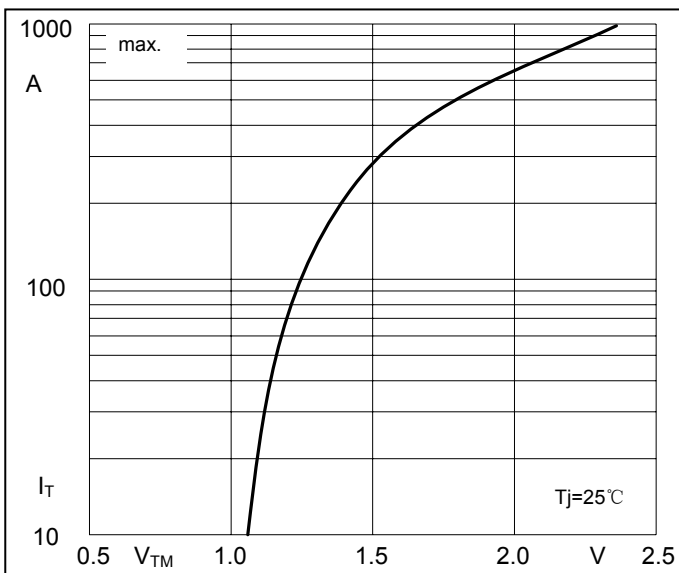


Fig9. SCR Forward Characteristics

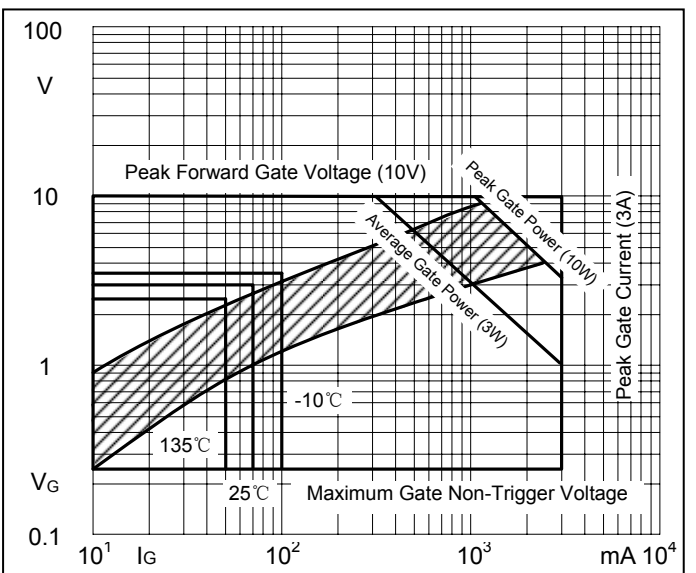
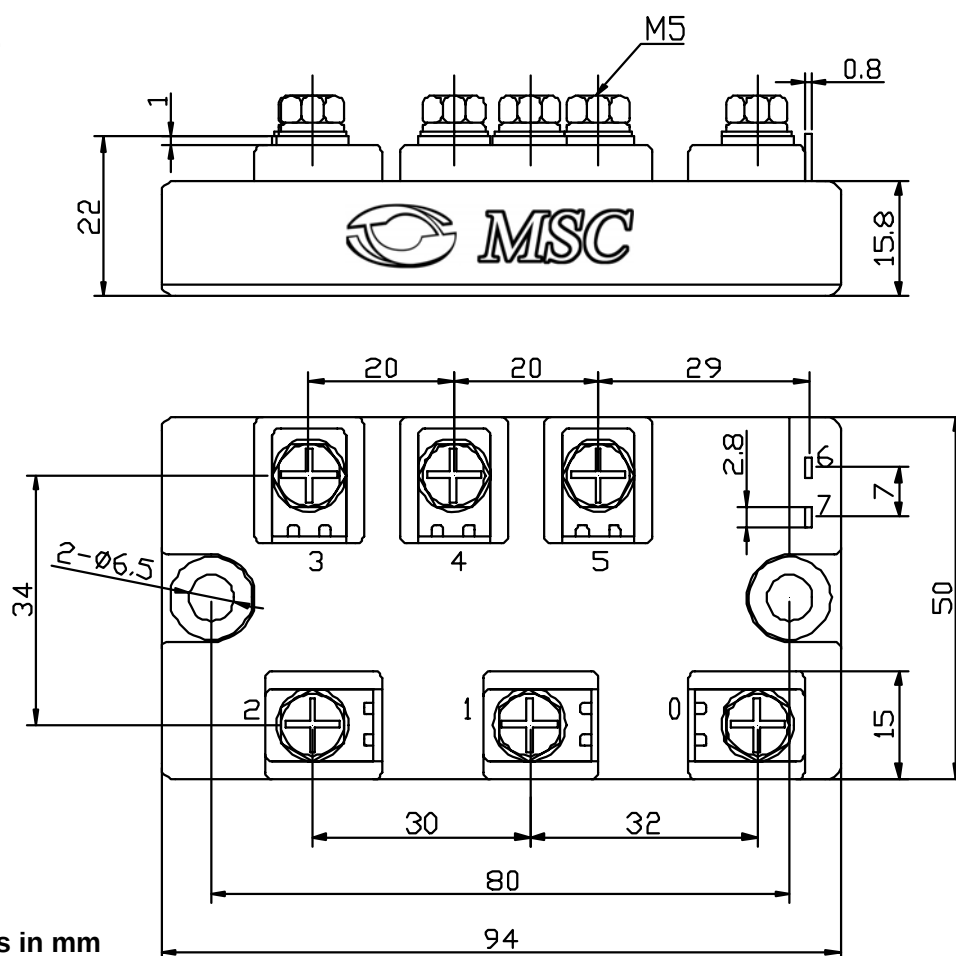


Fig10. Gate trigger Characteristics

Package Outline Information

CASE: M4



Dimensions in mm